

60V 50A N-channel Enhancement Mode Power MOSFET

Description

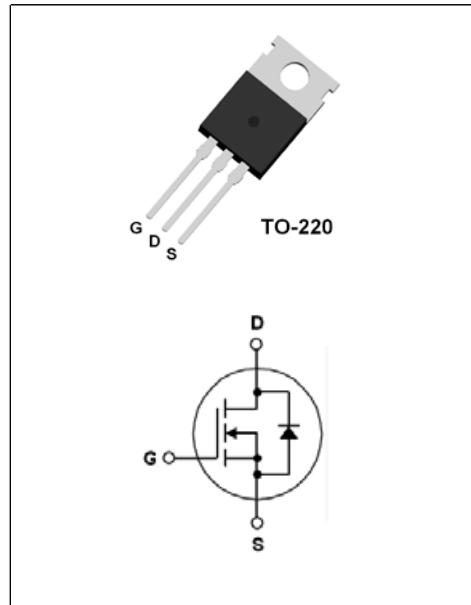
The AKT50N06T is an N-Channel enhancement mode power MOSFET, it has low static on-resistance and high avalanche energy strength. This device provide excellent switching performance for switched mode power supplies, low voltage applications such as DC/DC converters.

Features

- Low on-Resistance: $R_{DS(on)}=0.018\Omega(\text{typ.})$
- Special Process Technology for high ESD Capability
- 100% Avalanche Test
- Good Stability and Uniformity with High E_{AS}

Applications

- Switched Mode Power Supplies
- Low Voltage Applications Such as DC/DC Converters



Absolute Maximum Ratings @ $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter		Ratings	Unit
V_{DSS}	Drain to Source Voltage		60	V
V_{GSS}	Gate to Source Voltage		± 25	V
I_D	Drain Current	$T_C=25^\circ\text{C}$	50	A
		$T_C=100^\circ\text{C}$	35.4	A
I_{DM}	Pulsed Drain Current	(Note1)	200	A
P_D	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	130	W
	Derate above 25°C		0.8	W/ $^\circ\text{C}$
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	720	mJ
T_J	Operating Junction Temperature Range		-55~+175	$^\circ\text{C}$
T_{STG}	Storage Temperature Range		-55~+175	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{th(J-C)}$	Thermal Resistance, Junction to case	1.24	$^\circ\text{C}/\text{W}$
$R_{th(J-A)}$	Thermal Resistance, Junction to Ambient	62.5	$^\circ\text{C}/\text{W}$

Electrical Characteristics @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain to Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	60	-	-	V
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2	3.35	4	V
$R_{DS(\text{on})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=25\text{A}$	-	0.018	-	Ω
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=V_{DSS}, V_{GS}=0\text{V}$	-	-	1	μA
I_{GSS}	Gate to Source Leakage Current	$V_{GS}=V_{GSS}, V_{DS}=0\text{V}$	-	-	± 100	nA

D-S Diode Characteristics and Maximum Rating @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Maximum Drain to Source Diode Forward Current		-	-	50	A
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS}=0\text{V}, I_S=50\text{A}$	-	1.03	1.5	V
T_{rr}	Reverse Recovery Time		-	50	-	ns
Q_{rr}	Reverse Recovery Charge	$V_{GS}=0\text{V}, I_S=50\text{A}, \frac{dI}{dt}=-100\text{A}/\text{us}$	-	75	-	nC

Switching Characteristics @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$t_{d(\text{on})}$	Turn-on Delay Time	$I_D=25\text{A}, V_{DD}=30\text{V}, R_G=25\Omega$ (Note 3)	-	15	40	ns
t_r	Turn-on Rise Time		-	105	220	ns
$t_{d(\text{off})}$	Turn-off Delay Time		-	60	130	ns
t_f	Turn-off Fall Time		-	65	140	ns
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1.0\text{MHz}$	-	1180	1540	pF
C_{oss}	Output Capacitance		-	440	580	pF
C_{rss}	Reverse Transfer Capacitance		-	65	90	pF
Q_g	Total Gate Charge	$I_D=50\text{A}, V_{DD}=48\text{V}$ $V_{GS}=10\text{V}$ (Note 3)	-	31	41	nC
Q_{gs}	Gate to Emitter Charge		-	8	-	nC
Q_{gd}	Gate to Collector Charge		-	13	-	nC

Note:

1. Repetitive rating: pulse-width limited by maximum junction temperature
2. $V_{DD}=25\text{V}, L=0.5\text{mH}, V_{\text{clamp}}=1500\text{V}, V_g=10\text{V}, I_d=50\text{A}$
3. Essentially independent of operating temperature typical characteristics

Typical Performance Characteristics

Fig. 1. Typical on-Resistance Characteristics

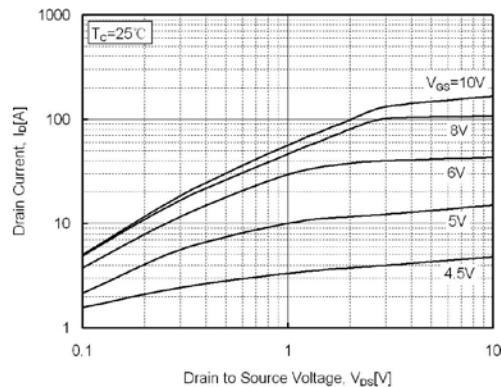


Fig. 2. Typical Transfer Characteristics

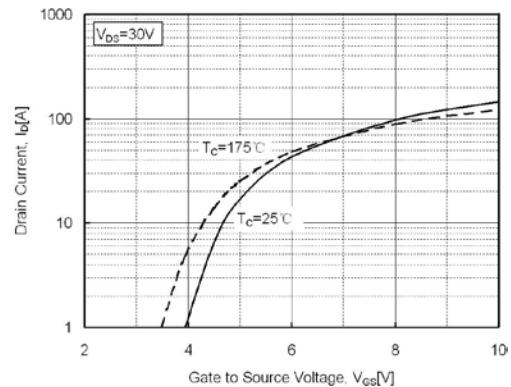


Fig. 3. Static on-Resistance vs. I_D

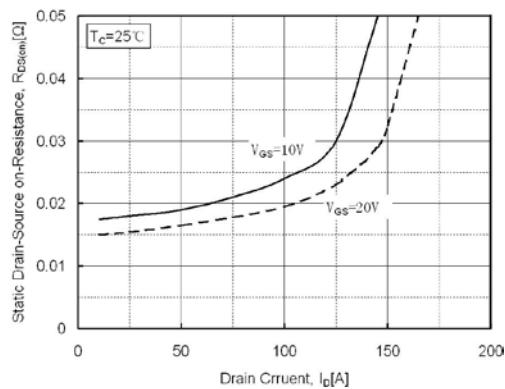


Fig. 4. Body Diode Forward Voltage vs. I_{DR}

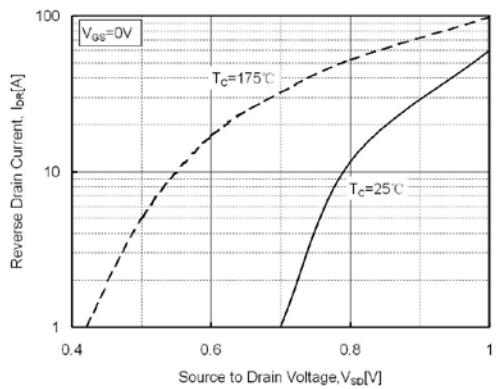


Fig. 5. Capacitance Characteristics

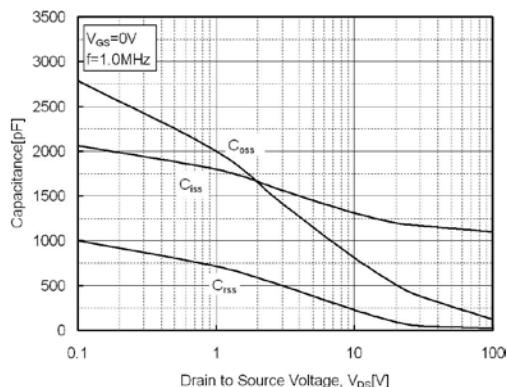
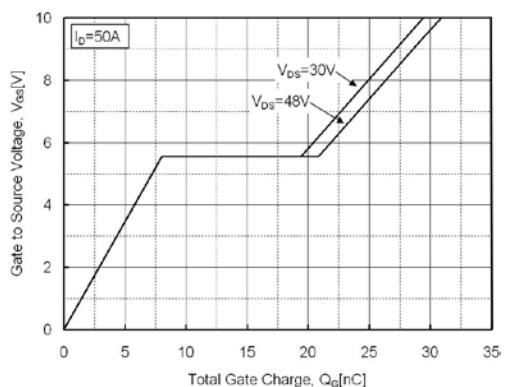


Fig. 6. Gate Charge Characteristics



Typical Performance Characteristics

Fig. 7. Breakdown Voltage vs. Temperature

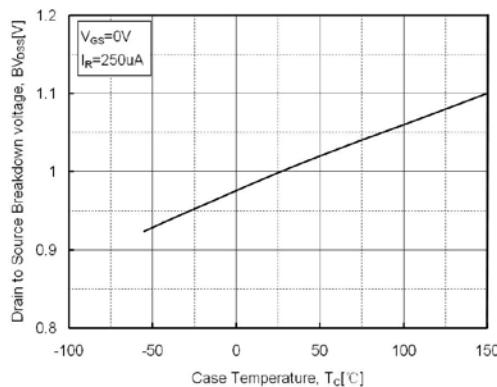


Fig. 8. Static on-Resistance vs. Temperature

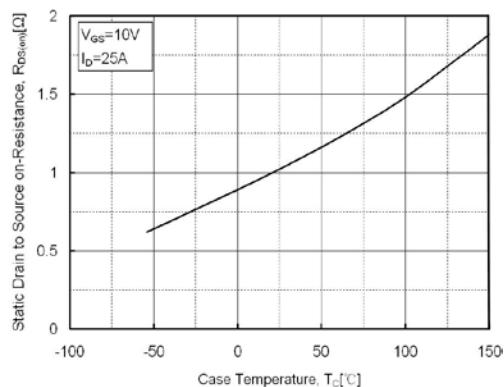


Fig. 9. Maximum Safe Operating Area

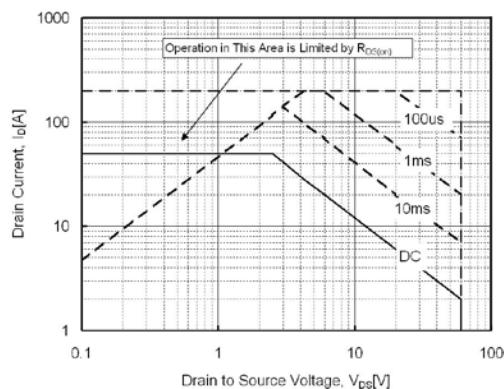


Fig. 10. Maximum Drain Current vs. Temperature

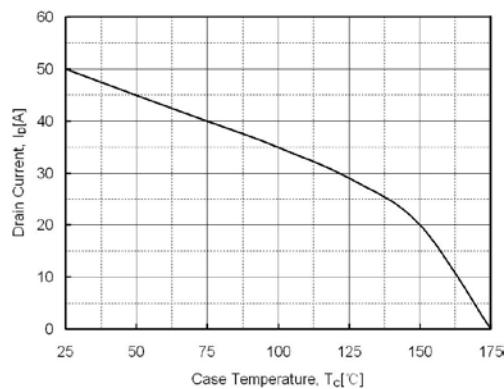
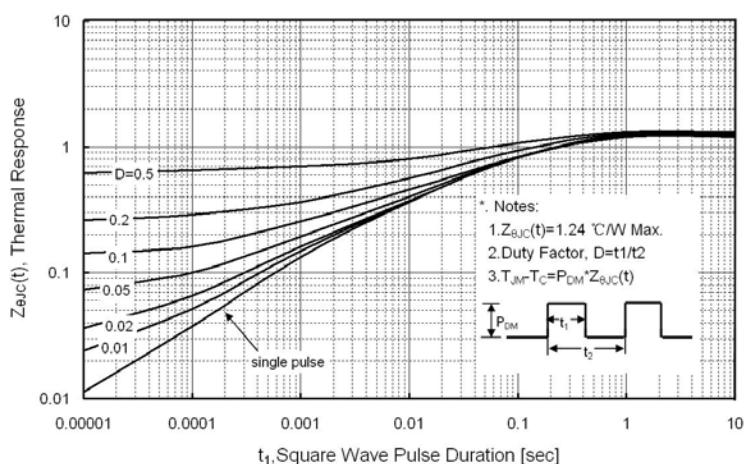


Fig. 11. Transient Thermal Response Curve



Package Dimensions

TO-220

(Dimensions in Millimeters)

